

Low-Voltage 16-Bit Buffer/Line Driver with 3.6 V Tolerant Inputs and Outputs

74ALVC16244

General Description

The ALVC16244 contains sixteen non-inverting buffers with 3-STATE outputs to be employed as a memory and address driver, clock driver, or bus oriented transmitter/receiver. The device is nibble (4-bit) controlled. Each nibble has separate 3-STATE control inputs which can be shorted together for full 16-bit operation.

The 74ALVC16244 is designed for low voltage (1.65 V to 3.6 V) $V_{\rm CC}$ applications with I/O capability up to 3.6 V.

The 74ALVC16244 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining low CMOS power dissipation.

Features

- 1.65 V 3.6 V V_{CC} Supply Operation
- 3.6 V Tolerant Inputs and Outputs
- t_{PD}
 - $\bullet~3.0~\text{ns}$ max for 3.0 V to 3.6 V V_{CC}
 - \bullet 3.5 ns max for 2.3 V to 2.7 V V_{CC}
 - 6.0 ns max for 1.65 V to 1.95 V V_{CC}
- Power-off High Impedance Inputs and Outputs
- Supports Live Insertion and Withdrawal*
- Uses Patented Noise/EMI Reduction Circuitry
- Latch-up conforms to JEDEC JED98
- ESD Performance:
 - ♦ Human Body Model >2000 V
 - ♦ Machine Model >200 V
- These are Pb-Free Devices

^{*}To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pull-up resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

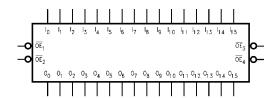
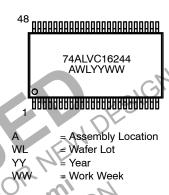


Figure 1. Logic Symbol



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

Connection Diagram

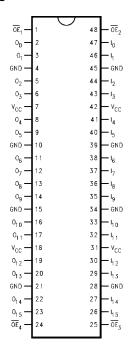


Figure 2. Pin Assignment for TSSOP

PIN DESCRIPTION

Pin Names	Description
OE _n	Output Enable Input (Active LOW)
I ₀ -I ₁₅	Inputs
O ₀ -O ₁₅	Outputs
NC	No Connect
TH	S DEVICE PLEASENTA REPRESENTA

TRUTH TABLE

Inp	uts	Outputs
ŌE ₁	l ₀ -l ₃	O ₀ -O ₃
L	L	L
L	Н	Н
Н	X	Z

OE ₃	I ₈ -I ₁₁	O ₈ -O ₁₁
L	L	L
L	Н	Н
Н	X	Z

ŌĒ ₂	I ₄ -I ₇	O ₄ -O ₇
L L	L H	TCN
Н	X) SZ

ŌĒ ₄	I ₁₂ -I ₁₅	O ₁₂ -O ₁₅
1	The state of the s	L H
Н	x elli	Z

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial (HIGH or LOW, inputs may not float)

Z = High Impedance

Functional Description

The 74ALVC16244 contains sixteen non–inverting buffers with 3–STATE outputs. The device is nibble (4 bits) controlled with each nibble functioning identically, but independent of each other. The control pins may be shorted together to obtain full 16–bit operation. The 3–STATE outputs are controlled by an Output Enable (\overline{OE}_n) input. When \overline{OE}_n is LOW, the outputs are in the 2–state mode. When \overline{OE}_n is HIGH, the standard outputs are in the high impedance mode but this does not interfere with entering new data into the inputs.

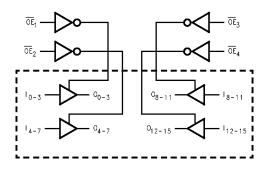


Figure 3. Logic Diagram

74ALVC16244

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Supply Voltage	V _{CC}	-0.5 to +4.6	V
DC Input Voltage	V _I	-0.5 to +4.6	V
Output Voltage (Note 1)	V _O	-0.5 to V _{CC} + 0.5	V
DC Input Diode Current, V _I < 0 V	I _{IK}	-50	mA
DC Output Diode Current, V _O < 0 V	I _{OK}	-50	mA
DC Output Source/Sink Current	I _{OH} /I _{OL}	±50	mA
DC V _{CC} or GND Current per Supply Pin	I _{CC} or GND	±100	mA
Storage Temperature Range	T _{STG}	-65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS (Note 2)

Symbol	Parameter	Min	Max	Unit
V _{CC}	Power Supply Operating Voltage	1.65	3.6	V
VI	Input Voltage	0	V _{CC}	V
Vo	Output Voltage	0	V _{CC}	V
T _A	Free Air Operating Temperature	O-40	85	°C
$\Delta t/\Delta V$	Input Edge Rate, V _{IN} = 0.8 V to 2.0 V, V _{CC} = 3.0 V	0.5	10	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Conditions	V _{CC} (V)	Min	Max	Units
V _{IH}	HIGH Level Input Voltage	COMMERC	1.65 – 1.95 2.3 – 2.7 2.7 – 3.6	0.65 x V _{CC} 1.7 2.0		V
V _{IL}	LOW Level Input Voltage	SENTA	1.65 – 1.95 2.3 – 2.7 2.7 – 3.6		0.35 x V _{CC} 0.7 0.8	V
V _{OH}	HIGH Level Output Voltage	I _{OH} = -100 μA	1.65 – 3.6	V _{CC} - 0.2		
	US DEF	I _{OH} = -4 mA	1.65	1.2		
<	YIO KI	I _{OH} = -6 mA	2.3	2.0		
		I _{OH} = -12 mA	2.3	1.7		V
			2.7	2.2		•
			3.0	2.4		
		I _{OH} = -24 mA	3.0	2		
V_{OL}	LOW Level Output Voltage	I _{OL} = 100 μA	1.65 – 3.6		0.2	
		I _{OL} = 4 mA	1.65		0.45	
		I _{OL} = 6 mA	2.3		0.4	
		I _{OL} = 12 mA	2.3		0.7	V
			2.7		0.4	
		I _{OL} = 24 mA	3.0		0.55	
I _I	Input Leakage Current	$0 \le V_I \le 3.6 \text{ V}$	3.6		±5.0	μΑ
l _{OZ}	3-STATE Output Leakage	$0 \le V_O \le 3.6 \text{ V}$	3.6		±10	μΑ
Icc	Quiescent Supply Current	V _I = V _{CC} or GND, I _O = 0	3.6		40	μΑ
ΔI_{CC}	Increase in I _{CC} per Input	V _{IH} = V _{CC} - 0.6 V	3 – 3.6		750	μΑ

^{1.} IO Absolute Maximum Rating must be observed, limited to 4.6 V.

^{2.} Floating or unused control inputs must be held HIGH or LOW.

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AC ELECTRICAL CHARACTERISTICS

			$T_A = -40^{\circ}C$ to $+85^{\circ}C$, $R_L = 500 \Omega$							
			C _L = 50 pF				C _L =	30 pF		
		V _{CC} = 3.3	V _{CC} =	2.7 V	V _{CC} = 2.5	5 V ±0.2 V	V _{CC} = 1.8	V ±0.15 V		
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Min	Max	Units
t _{PHL} , t _{PLH}	Propagation Delay	1.3	3	1.5	3.5	1.0	3.0	1.5	6.0	ns
tpzl, tpzh	Output Enable Time	1.3	4.0	1.5	4.6	1.0	4.1	1.5	8.2	ns
t _{PLZ} , t _{PHZ}	Output Disable Time	1.3	4.0	1.5	4.3	1.0	3.8	1.5	6.8	ns

CAPACITANCE

				T _A =	+25°C	
Symbol	Parameter		Conditions	V _{CC}	Typical	Units
C _{IN}	N Input Capacitance		V _I = 0 V or V _{CC}	3.3	6	pF
C _{OUT}	Output Capacitance		V _I = 0 V or V _{CC}	3.3	7	p F
C _{PD}	Power Dissipation Capacitance	Outputs Enabled	f = 10 MHz, C _L = 0 pF	3.3 2.5	20	pF
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74ALVC16244

AC Loading and Waveforms

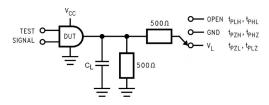


Figure 4. AC Test Circuit

Values for Figure 4

Test	Switch
tplH, tpHL	Open
tpzl, tplz	V_{L}
tpzh, tphz	GND

VARIABLE MATRIX

(Input Characteristics: f = 1 MHz; $t_r = t_f = 2 \text{ ns}$; $Z_0 = 50 \Omega$)

	V _{CC}								
Symbol	3.3 V ±0.3 V	2.7 V	2.5 V ±0.2 V	1.8 V ±0.15 V					
V _{mi}	1.5 V	1.5 V	V _{CC} /2	V _{CC} /2					
V _{mo}	1.5 V	1.5 V	V _{CC} /2	V _{CC} /2					
V _X	V _{OL} + 0.3 V	V _{OL} + 0.3 V	V _{OL} + 0.15 V	V _{OL} + 0.15 V					
V _Y	V _{OH} – 0.3 V	V _{OH} – 0.3 V	V _{OH} – 0.15 V	V _{OH} – 0.15 V					
V_L	6 V	6 V	V _{CC} *2	V _{CC} * 2					

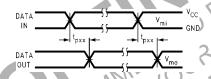


Figure 5. Waveform for Inverting and Non-Inverting Functions

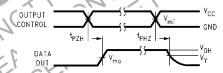


Figure 6. 3-STATE Output High Enable and Disable Times for Low Voltage Logic

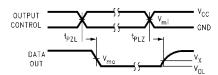


Figure 7. 3-STATE Output Low Enable and Disable Times for Low Voltage Logic

ORDERING INFORMATION

Device	Package	Shipping [†]	
74ALVC16244MTDX	TSSOP48 12.5x6.1 (Pb-Free)	1000 Units / Tape & Reel	

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

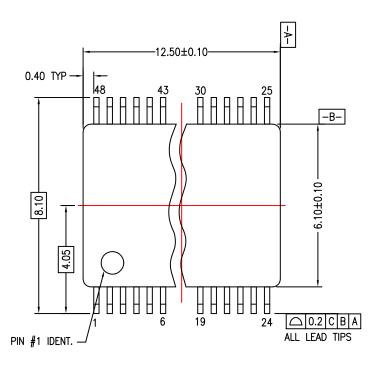


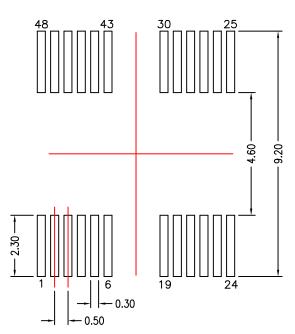


TSSOP48 12.5x6.1

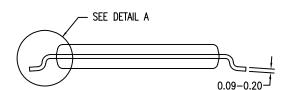
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DATE 30 SEP 2016





1.2 MAX — ALL LEAD TIPS — 0.90^{+0.15} — 0.90^{+0.15} — 0.17-0.27 — 0.10±0.05 — 0.13@ A B\$ C\$

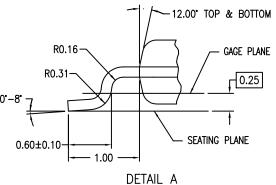


LAND PATTERN RECOMMENDATION

DIMENSIONS ARE IN MILLIMETERS

NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION ED, DATE 4/97.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.



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